

2SK2393

Silicon N Channel MOS FET

REJ03G1010-0200

(Previous: ADE-208-1357)

Rev.2.00 Sep 07, 2005

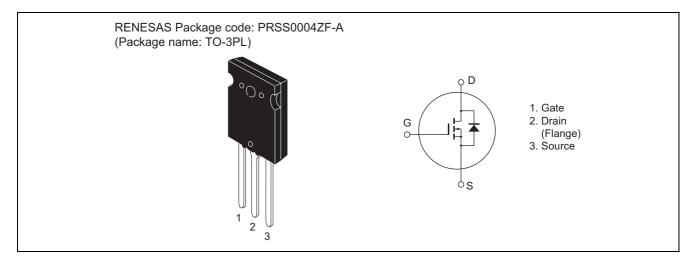
Application

High voltage / High speed power switching

Features

- Low on-resistance, High breakdown voltage
- High speed switching
- Low drive current
- No secondary breakdown
- Suitable for switching regulator, motor control

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	1500	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I _D	8	А
Drain peak current	I _{D(pulse)} *1	20	A
Body to drain diode reverse drain current	I _{DR}	8	А
Channel dissipation	Pch*2	200	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at Tc = 25°C

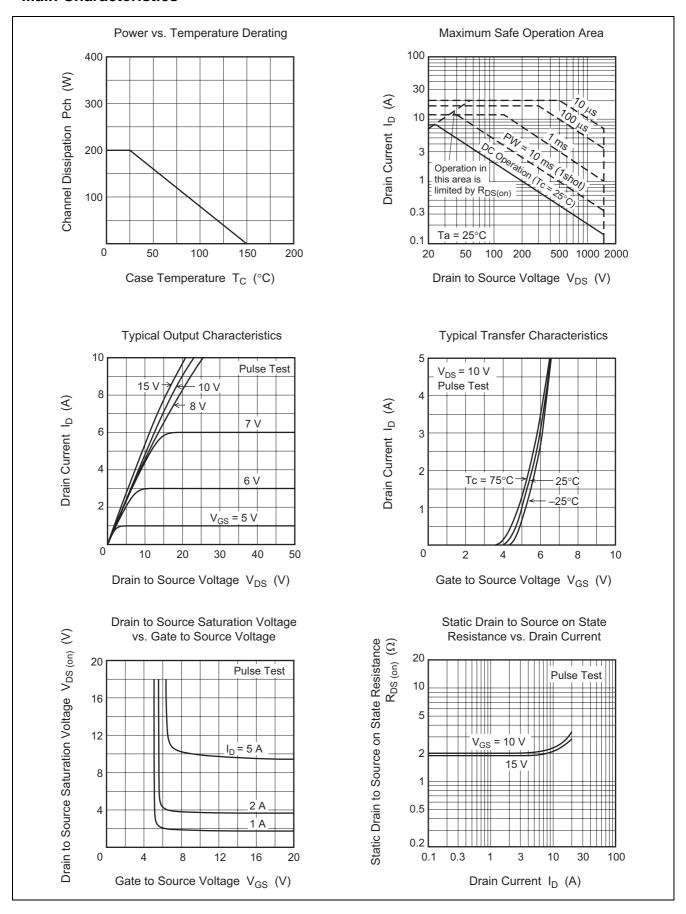
Electrical Characteristics

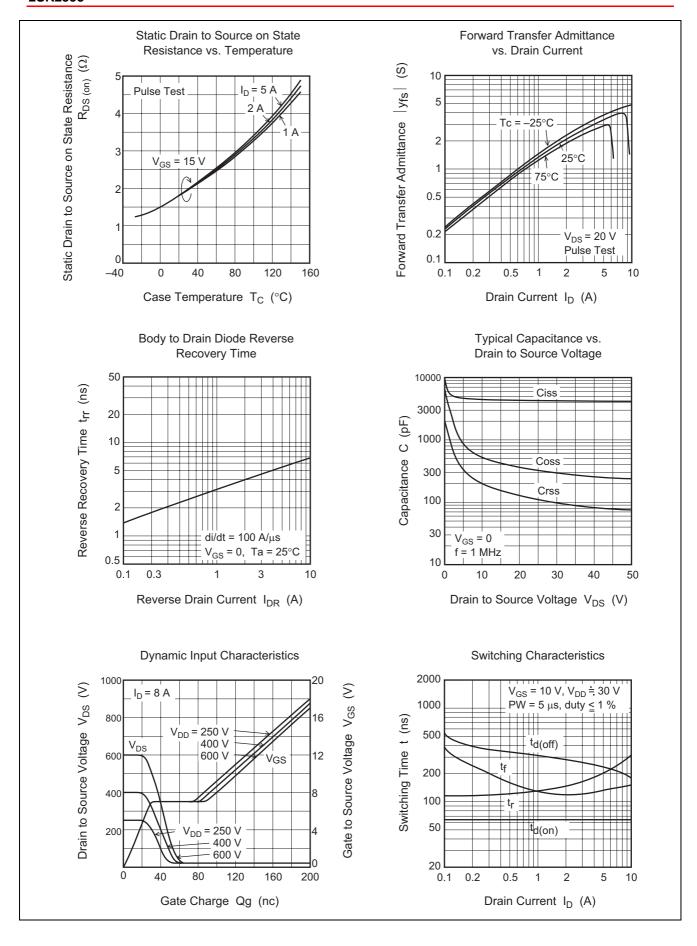
 $(Ta = 25^{\circ}C)$

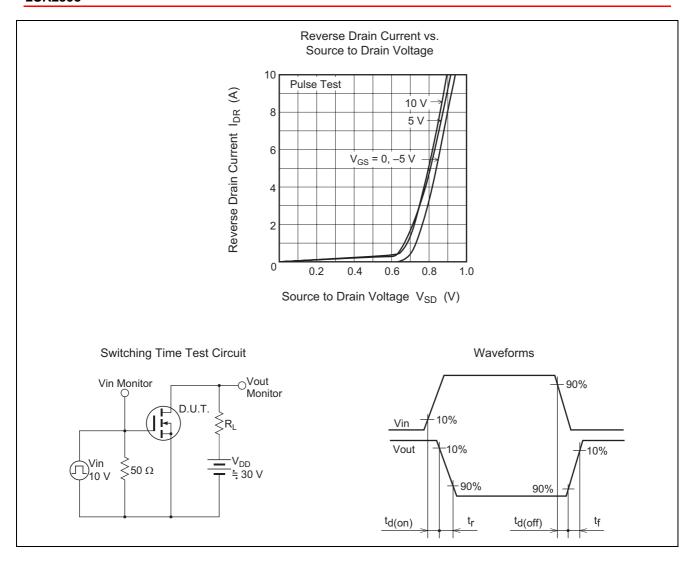
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	1500	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0^{*1}$
Gate to source leak current	I _{GSS}	_	_	±1	μΑ	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	_	500	μΑ	$V_{DS} = 1200 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	2.0	_	4.0	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state	R _{DS(on)}	_	1.9	2.8	Ω	$I_D = 4 \text{ A}, V_{GS} = 15 \text{ V}^{*3}$
resistance						
Forward transfer admittance	y _{fs}	1.8	3.0	_	S	$I_D = 4 \text{ A}, V_{DS} = 20 \text{ V}^{*3}$
Input capacitance	Ciss	_	4370	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$
Output capacitance	Coss	_	560	_	pF	f = 1 MHz
Reverse transfer capacitance	Crss	_	200	_	pF	
Turn-on delay time	t _{d(on)}	_	75	_	ns	$I_D = 4 A, V_{GS} = 10 V,$
Rise time	t _r	_	180	_	ns	$R_L = 7.5 \Omega$
Turn-off delay time	t _{d(off)}	_	260	_	ns]
Fall time	t _f	_	125	_	ns]
Body to drain diode forward voltage	V_{DF}	_	0.9	_	V	I _F = 8 A, V _{GS} = 0
Body to drain diode reverse	t _{rr}	_	6.5	_	μs	$I_F = 8 A, V_{GS} = 0,$
recovery time						$di_{F} / dt = 100 A / \mu s$

Note: 3. Pulse Test

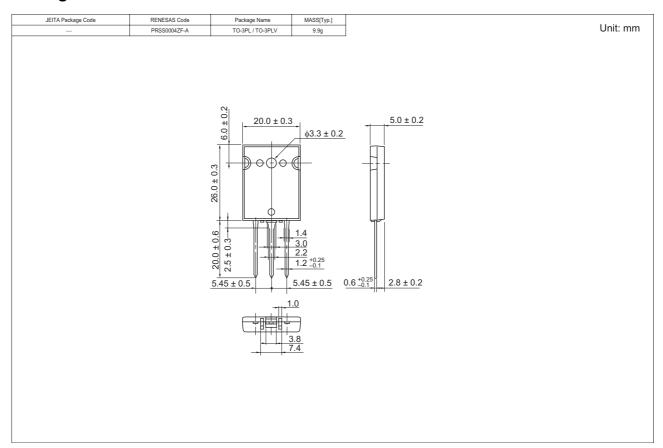
Main Characteristics







Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK2329-E	500 pcs	Box (Case)

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.

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